

CYStech Electronics Corp.

Spec. No.: C188LD Issued Date: 2013.03.05

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5.0Amp Schottky Barrier Rectifiers Reverse Voltage 200V Forward Current 5A

SB5200

Features

- Guard ring for over voltage protection.
- Plastic package has UL flammability classification 94V-0
- Low power loss, high efficiency
- For use in low voltage, high frequency inverters, free wheeling, and polarity protection applications

Outline



Mechanical Data

• Case: JEDEC DO-201AD molded plastic body

• Epoxy : UL94V-0 rate flame retardant

• Terminals: Plated axial leads, solderable per MIL-STD-750 method

2026. High temperature soldering guaranteed: 250°C/10seconds, 0.375"(9.5mm) lead length, 5lbs(2.3kg) tension

• Polarity: Color band denotes cathode end.

• Mounting Position : Any.

• Weight: 0.041 oz., 1.15 gram

Maximum Ratings and Electrical Characteristics

(Rating at 25°C ambient temperature unless otherwise specified. Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%)

Parameter	Symbol	Type SB5200	Units	
Maximum repetitive peak reverse v	Vrrm	200	V	
Maximum RMS voltage	VRMS	140	V	
Maximum DC blocking voltage	V _{DC}	200	V	
Maximum instantaneous forward v	V_{F}	0.92	V	
Maximum average forward rectified lead length (see Fig 1)	IF(AV)	5	A	
Peak forward surge current @8.3m superimposed on rated load (JEDE	IFSM	125	A	
Maximum DC reverse current at	TA=25°C	τ_	0.1	4
rated DC blocking voltage ¹	T _A =100°C	IR	5	— mA
Typical thermal resistance ²	R _θ JL	10	°C/W	
Operating junction temperature range	TJ	- 55 ∼ +175	$^{\circ}\mathbb{C}$	
Storage temperature range	Tstg	-55 ~ +175	$^{\circ}\mathbb{C}$	

Note: 1.Pulse test: pulse width≤300µs, duty cycle≤1%

2. Thermal resistance, junction to lead, vertical PCB mounted, 0.375"(9.5mm) lead length



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Characteristic Curves

Fig.1- Forward Current

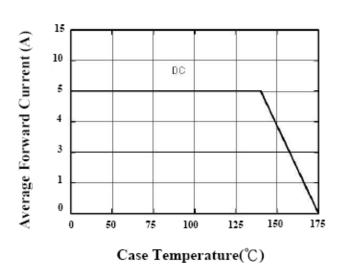


Fig.2- Typical Instantaneous Forward

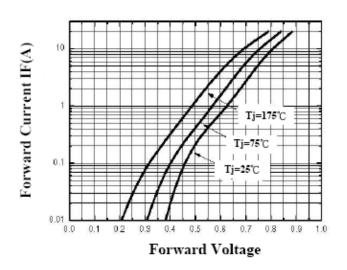


Fig.3- Typical Reverse

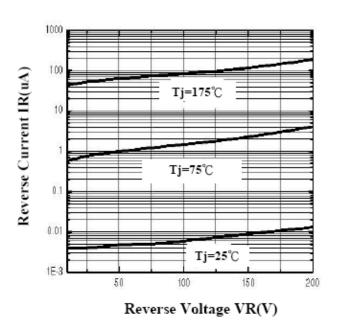
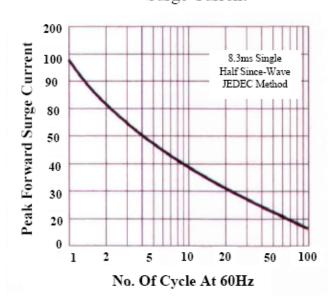


Fig.4- Tmaximum Non -Repetitive Surge Current



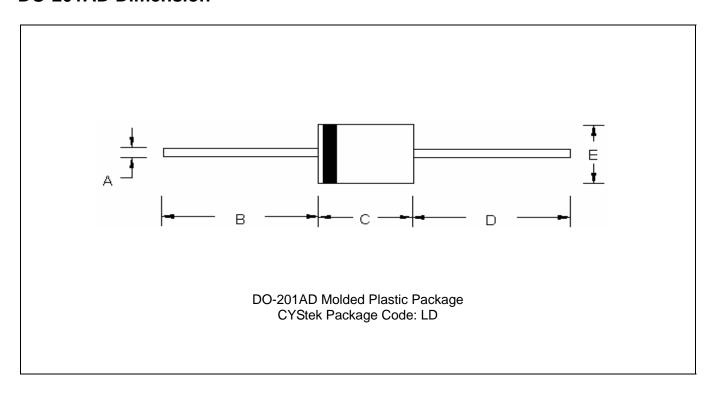


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DO-201AD Dimension



DIM	Inches		Millimeters		DIM	Inches		Millimeters	
	Min.	Max.	Min.	Max.	וווט	Min.	Max.	Min.	Max.
Α	φ0.048	φ0.052	φ1.20	φ1.30	D	1.000	-	25.40	-
В	1.000	-	25.40	-	Е	φ0.190	φ0.210	φ4.80	φ5.30
С	0.285	0.375	7.20	9.50					

Notes: 1.Controlling dimension: millimeters.

2.Maximum lead thickness includes lead finish thickness, and minimum lead thickness is the minimum thickness of base material. 3.If there is any question with packing specification or packing method, please contact your local CYStek sales office.

Material:

- Lead : Axial leads, solderable per MIL-STD-750, Method 2026 guaranteed.
- Mold Compound: Epoxy resin family, flammability solid burning class: UL94V-0

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